

Description

The FMX-12S is a fast recovery diode of 200 V / 5 A. The maximum $t_{\rm rr}$ of 30 ns is realized by optimizing a life-time control.

Features

• V _{RM}	200 V
• I _{F(AV)}	5 A
• V _F	
• t _{rr1}	30 ns

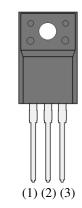
- Bare Lead Frame: Pb-free (RoHS Compliant)
- Flammability: Equivalent to UL94V-0

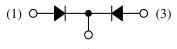
Applications

- Secondary-side Rectifier Diode (Flyback Converter, LLC Converter, etc.)
- Freewheel Diode (Offline Buck Converter, Offline Buck-boost Converter, etc.)

Package

TO220F-3L





- (2) (1) Anode
 - (2) Cathode
 - (3) Anode

Not to scale

FMX-12S

Absolute Maximum Ratings

Unless otherwise specified, $T_A = 25$ °C.

Parameter	Symbol	Conditions	Rating	Unit
Nonrepetitive Peak Reverse Voltage ⁽¹⁾	V_{RSM}		200	V
Repetitive Peak Reverse Voltage ⁽¹⁾	V_{RM}		200	V
Average Forward Current	$I_{F(AV)}$	See Figure 1 and Figure 2	5	A
Surge Forward Current ⁽¹⁾	I _{FSM}	Half cycle sine wave, positive side, 10 ms, 1 shot	35	A
I ² t Limiting Value ⁽¹⁾	I^2t	$1 \text{ ms} \le t \le 10 \text{ ms}$	6.1	A^2s
Junction Temperature	T_{J}		-40 to 150	°C
Storage Temperature	T_{STG}		-40 to 150	°C

Electrical Characteristics

Unless otherwise specified, $T_A = 25$ °C.

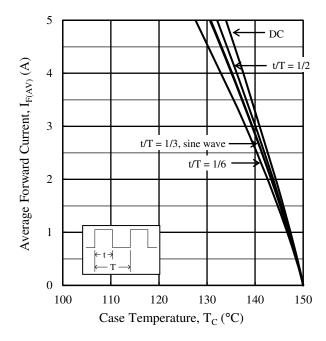
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
F 177 (1)	rward Voltage Drop ⁽¹⁾ V _F	$T_J = 25$ °C, $I_F = 2.5$ A	_	_	0.98	V
Forward Voltage Drop		$T_J = 100 ^{\circ}\text{C}, I_F = 2.5 \text{A}$	_	0.74	_	V
Reverse Leakage Current ⁽¹⁾	I_R	$V_R = V_{RM}$	_	_	50	μΑ
Reverse Leakage Current under High Temperature ⁽¹⁾	$H \cdot I_R$	$V_R = V_{RM}, T_J = 150 ^{\circ}C$	_	_	10	mA
	t _{rr1}	$I_F = I_{RP} = 100 \text{ mA},$ 90% recovery point, $T_J = 25 ^{\circ}\text{C}$	_	_	30	ns
Reverse Recovery Time ⁽¹⁾ t_{rr2}	t _{rr2}	$I_F = 100 \text{ mA},$ $I_{RP} = 200 \text{ mA},$ $75\% \text{ recovery point},$ $T_J = 25 \text{ °C}$	_	_	25	ns
Thermal Resistance ⁽²⁾	$R_{\text{th(J-C)}}$		_	_	4.0	°C/W

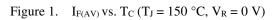
Mechanical Characteristics

Parameter	Conditions	Min.	Тур.	Max.	Unit
Heatsink Mounting Screw Torque		0.490	_	0.686	N·m
Package Weight		_	1.8	_	g

 $^{^{(1)}}$ Specifies a value per chip; the FMX-12S consists of two chips. $^{(2)}$ R_{th (J-C)} is thermal resistance between junction and the case. The case temperature is measured at the back side near the screw hole.

Derating Curves





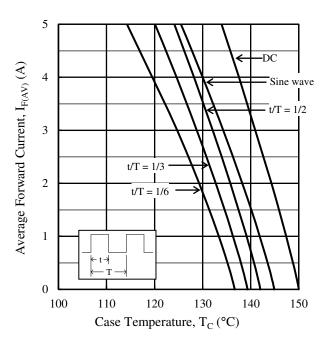


Figure 2. $I_{F(AV)}$ vs. T_C ($T_J = 150$ °C, $V_R = 200$ V)

Characteristic Curves

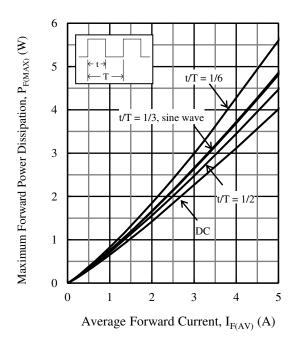


Figure 3. $P_{F(MAX)}$ vs. $I_{F(AV)}$ ($T_J = 150$ °C)

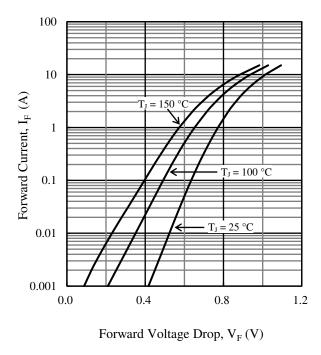


Figure 5. Typical Characteristics: I_F vs. V_F

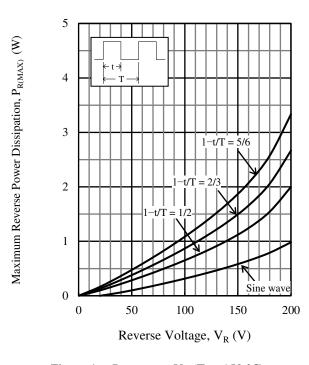


Figure 4. $P_{R(MAX)}$ vs. V_R ($T_J = 150$ °C)

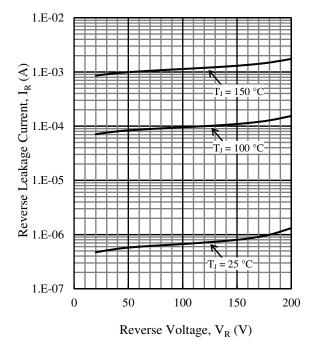


Figure 6. Typical Characteristics: I_R vs. V_R

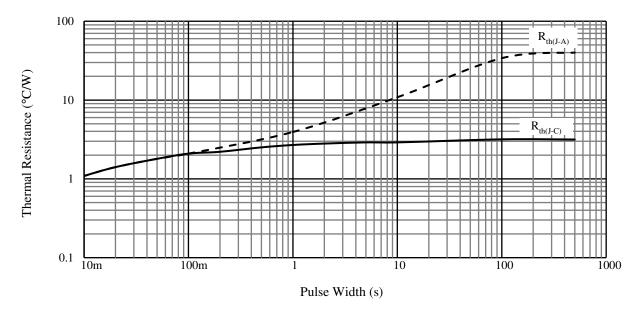
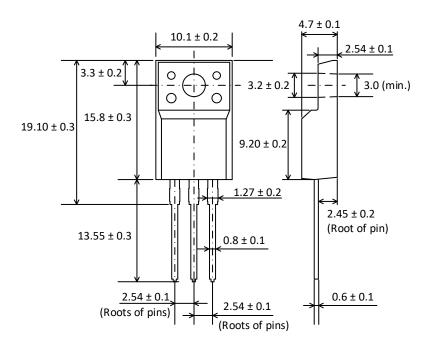


Figure 7. Typical Transient Thermal Resistance Characteristics

Physical Dimensions

• TO220F-3L



NOTES:

- Dimensions in millimeters
- All the dimensions exclude mold flashes.
- Bare lead frame: Pb-free (RoHS compliant)
- When soldering the products, it is required to minimize the working time within the following limits:

Flow: 260 °C / 10 s, 1 time

Soldering Iron: 350 °C / 3.5 s, 1 time

Soldering should be at a distance of at least 1.5 mm from the body of the product.

Marking Diagram

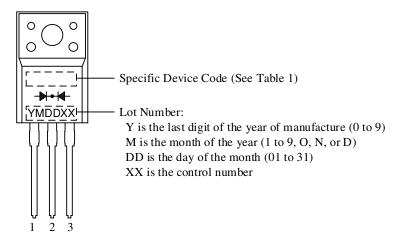


Table 1. Specific Device Code

Specific Device Code	Part Number
FMX12S	FMX-12S

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